



Product Change Notification

Change Notification #: 114317 - 00
Change Title: Intel® Server Chassis P4304XXSHDR
PCN 114317 - 00, Label
Update Regulatory and Safety Labels,
Add new KCC certification logo to PSU label
Date of Publication: January 5, 2016

Key Characteristics of the Change:

Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material *:	January 20, 2016
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing the following changes on the Intel® Server Chassis P4304XXSHDR:

1. Update the packaging regulatory label, with New Australia/New Zealand (RCM) Logo and the Safety Nemko Logo. Please see Figure-1 and Figure-2 below for details.



Figure-1: Pre-Change



Figure-2: Post-change

- Update the regulatory label with New Australia/New Zealand (RCM) Logo and the Safety Nemko Logo. Please see Figure-3 and Figure-4 below for details.



Figure-3: Pre-Change



Figure-4: Post-Change

3. New KCC certification has been applied to Intel Power Supply Units. A new KCC logo is added to Power Supply Unit label. Please reference Label Example below.

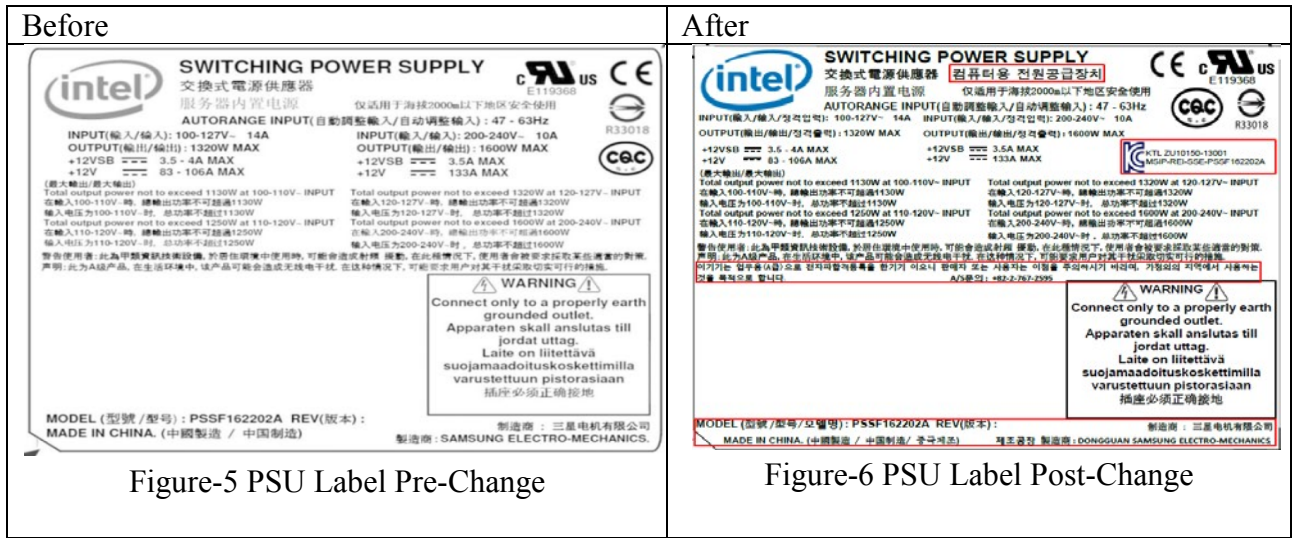


Figure-5 PSU Label Pre-Change

Figure-6 PSU Label Post-Change

Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
P4304XXSHDR	916171	G51302-002	G51302-003

PCN Revision History:

Date of Revision: January 5, 2016	Revision Number: 00	Reason: Originally Published PCN
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Product Change Notification

#114317 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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